

#3GP/1624



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: **Yong Mi Choi-Sledeski, Heinz W. Pauls, Jeffrey N. Barton, William R. Ewing, Daniel M. Green, Michael R. Becker, Yong Gong, Julian Levell**

Application. No.: **09/918,039** Examiner:  
Filed: **July 30, 2001** Group Art Unit: **1624**  
For: **Sulfonic Acid or Sulfonylamino N-(Heteroaralkyl)-Azaheterocyclamide Compounds**

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Attorney Docket No.: **A2513-E US DIV 1**

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first-class mail, postage prepaid, in an envelope addressed to: Commissioner for Patents, Washington, DC 20231, Attn: Office of Initial Patent Examination's Customer Service Center on October 11, 2001.

Dated: October 11, 2001

Denise M. Porreca  
Denise M. Porreca

Commissioner for Patents  
Washington, DC 20231  
Attn: Office of Initial Patent Examination's  
Customer Service Center

REQUEST FOR CORRECTION OF FILING RECEIPT

Upon review of the recently received Filing Receipt for the above U.S. patent application, it was discovered that the following errors are detailed below:

The address of the named inventor **Daniel M. Green** has been incorrectly entered.

"Ambler, PANAMA" should read - - Ambler, PA - -

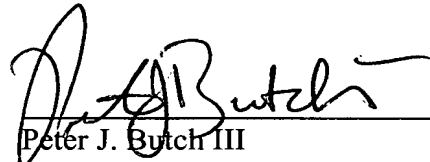
The above corrections are due to typographical errors on the part of the United States Patent and Trademark Office, and is not due to any error by Applicants; therefore, no fee is due.

Applicant(s): Yong Mi Choi-Sledeski et al.  
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In view of the above, Applicants respectfully requests the issuance of a Corrected Filing Receipt indicating the correct address for inventor **Daniel M. Green**.

Respectfully submitted,

Dated October 11, 2001

  
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Peter J. Butch III  
Reg. No. 32,203

Synnestvedt & Lechner LLP  
2600 Aramark Tower  
1101 Market Street  
Philadelphia, PA 19107-2950  
Telephone: (215) 923-4466  
Facsimile: (215) 923-2189

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Enclosures